SaRonix

Voltage Controlled Crystal Oscillator

3.3V, LVCMOS

S1300 / S1309 / ST1300 / ST1309 Series

Technical Data



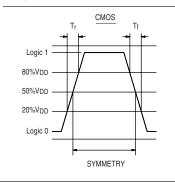
Description

A 3.3V, voltage controlled crystal oscillator with output logic levels compatible with LVCMOS and LVTTL logic families. The series is designed with excellent Jitter characteristics which makes it ideal for use in Telecom and Datacom applications. True SMD DIL versions for IR reflow are available, select option "S" in part number builder. See separate data sheet for SMD package dimensions.

Applications & Features

- Phase-Locked Loop (PLL) Clock and Data Recovery, Frequency Transaltion, Frequency Synthesis apps in Video, Video Compression, Telephony, and LAN/WAN Data Communication
- 3.3 Volt operations
- LVCMOS / LVTTL compatible
- 3.5ps max RMS period jitter
- Wide range of performance options: ± 50 to $\pm 100~ppm~~APR*$ ± 20 to ± 50 ppm Frequency Stability
- Tri-State option
- True SMD for IR reflow available

Output Waveform



temperature, voltage change, load change, calibra tolerance, shock and vibration, with V _C = 1.65V Aging @ 25°C: \pm 3ppm max per year, \pm 10ppm max for 10 years Temperature Range: Operating: 0 to +70°C or -40 to +85°C Storage: -55 to +125°C Supply Voltage: Recommended Operating: 3.3V \pm 10% Supply Current: 10mA typ, 15mA max Output Drive: 45/55% max @ 50% VDD Rise & Fall Times: 9ns max 20% to 80% VDD Logic 0: 10% VDD max Logic 1: 90% VDD min Load: 30pF Jitter: 3.5ps max RMS period jitter Pull Characteristics: Input Impedance (pin 1): Soft 0: 50KΩ min Frequency Response (-3dB): 10 kHz min Pullability: ±50, ±70, ±100ppm APR* min Control Voltage: 0.3 to 3.0V Transfer Function: Frequency Increases when Control Voltage Increases Linearity: 5 or 10% max Center Control Voltage: 1.65V Mechanical: MIL-STD-883, Method 2002, Condition B Solderability: MIL-STD-883, Method 2004, Condition B2 Vibration:	requency Stability:	1.5 MHz to 28.6363 MHz
The transformation of transform		± 20 , ± 25 or ± 50 ppm over all conditions: operating temperature, voltage change, load change, calibration tolerance, shock and vibration, with V _C = 1.65V
Operating: Storage: 0 to $+70^{\circ}$ C or -40 to $+85^{\circ}$ C -55 to $+125^{\circ}$ CSupply Voltage: Recommended Operating: $3.3V \pm 10\%$ Supply Current: $10mA$ typ, $15mA$ maxOutput Drive:Symmetry: Logic 0: Logic 0: Logic 1: $45/55\%$ max @ 50% VDD 	ging @ 25°C:	\pm 3ppm max per year, \pm 10ppm max for 10 years
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Vibration:MIL-STD-883, Method 2007, Condition ASolvent Resistance:MIL-STD-202, Method 215	5	
Solvent Resistance: MIL-STD-202, Method 215	Terminal Strength:	
	Vibration	
Resistance to Soldering field. MIL-STD-202, Method 210, Conditions A, D of C		MIL-STD-202, Method 210, Conditions A, B or C
(I or J for Gull Wing)	Solvent Resistance:	
Environmental:		
Gross Leak Test: MIL-STD-883C, Method 1014, Condition C	Solvent Resistance: Resistance to Soldering Heat:	MIL-STD-883C, Method 1014, Condition C
	Solvent Resistance: Resistance to Soldering Heat: nvironmental: Gross Leak Test:	
	Solvent Resistance: Resistance to Soldering Heat: nvironmental: Gross Leak Test: Fine Leak Test:	MIL-STD-883C, Method 1014, Condition A2
monsture resistance. mill-51D-005C, method 1004	Solvent Resistance: Resistance to Soldering Heat: nvironmental: Gross Leak Test: Fine Leak Test: Thermal Shock:	MIL-STD-883C, Method 1011, Condition A
	Solvent Resistance: Resistance to Soldering Heat: nvironmental: Gross Leak Test: Fine Leak Test:	

* APR = (VCXO Pull relative to specified Output Frequency) - (VCXO Frequency Stability) NOTE: APR is inclusive of 10 Years Aging

> DS-126 REV E

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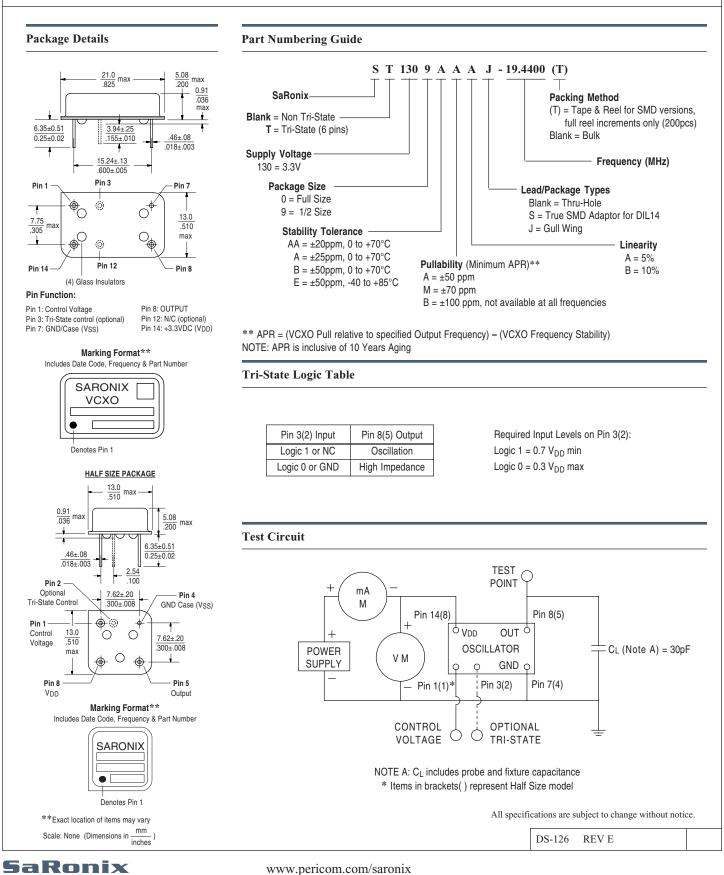


Voltage Controlled Crystal Oscillator

3.3V, LVCMOS

Technical Data

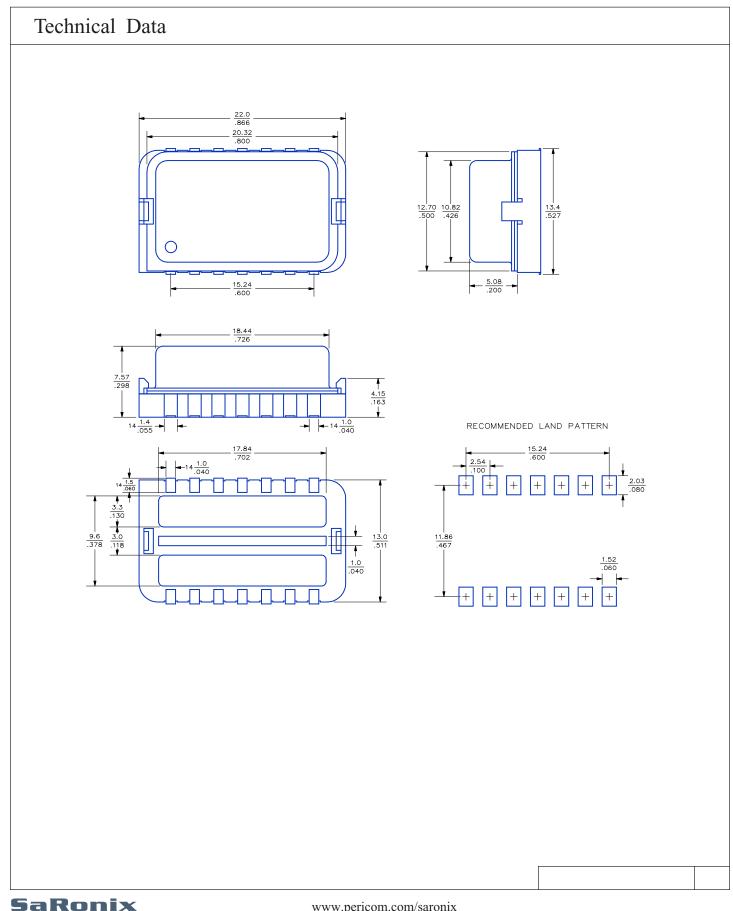
S1300 / S1309 / ST1300 / ST1309 Series



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True SMD Adaptor



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